

D1FT4

Schottky Barrier Diodes

40V, 2A

Feature

- Small SMD
- $T_j=175^{\circ}\text{C}$
- Ultra low I_R
- Based on AEC-Q101
- Pb free terminal
- RoHS:Yes

OUTLINE

Package (House Name): 1F
 Package (JEDEC Code): DO-214AC



Equivalent circuit



Absolute Maximum Ratings (unless otherwise specified : $T_l=25^{\circ}\text{C}$)

Item	Symbol	Conditions	Ratings	Unit
Storage temperature	T_{stg}		-55 to 175	$^{\circ}\text{C}$
Junction temperature	T_j		175	$^{\circ}\text{C}$
Repetitive peak reverse voltage	V_{RRM}		40	V
Average forward current	$I_F(AV)$	50Hz sine wave, Resistance load, $T_l=143^{\circ}\text{C}$	2	A
Average forward current	$I_F(AV)$	50Hz sine wave, Resistance load, On alumina substrate, $T_a=25^{\circ}\text{C}$	2	A
Average forward current	$I_F(AV)$	50Hz sine wave, Resistance load, On glass-epoxy substrate, $T_a=25^{\circ}\text{C}$	1.5	A
Surge forward current	I_{FSM}	50Hz sine wave, Non-repetitive, 1 cycle, Peak value, $T_j=25^{\circ}\text{C}$	60	A

* : See the original Specifications

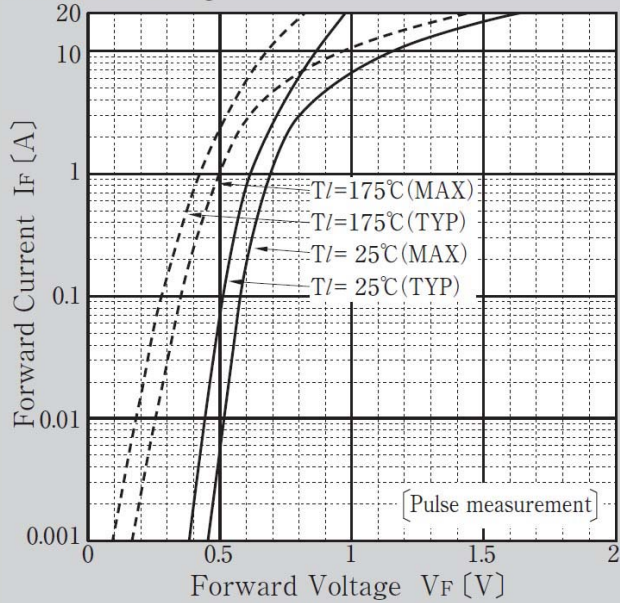
Electrical Characteristics (unless otherwise specified : Tl=25°C)

Item	Symbol	Conditions	Ratings			Unit
			MIN	TYP	MAX	
Forward voltage	V_F	IF=2.0A, Pulse measurement			0.74	V
Forward voltage	V_F	IF=1.0A, Pulse measurement			0.69	V
Reverse current	I_R	VR=40V, Pulse measurement			0.005	mA
Total capacitance	C_t	f=1MHz, VR=10V		63		pF
Thermal resistance	Rth(j-l)	Junction to lead			23	°C/W
Thermal resistance	Rth(j-a)	Junction to ambient, On alumina substrate			108	°C/W
Thermal resistance	Rth(j-a)	Junction to ambient, On glass-epoxy substrate			157	°C/W

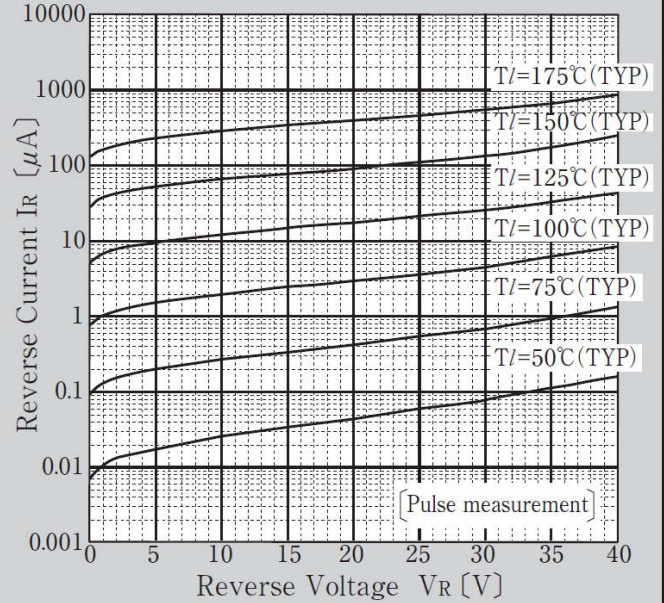
* :See the original Specifications

CHARACTERISTIC DIAGRAMS

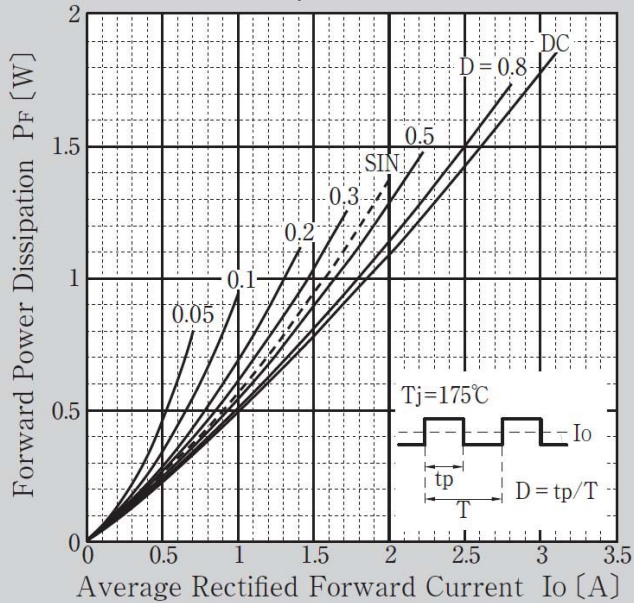
Forward Voltage



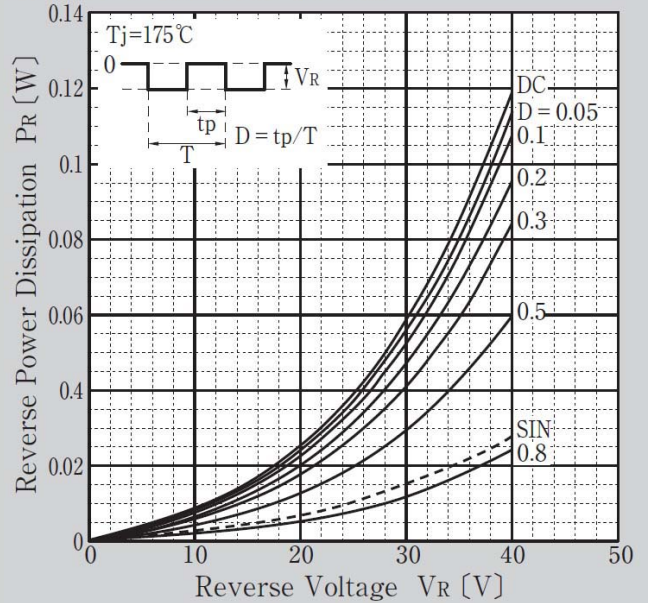
Reverse Current

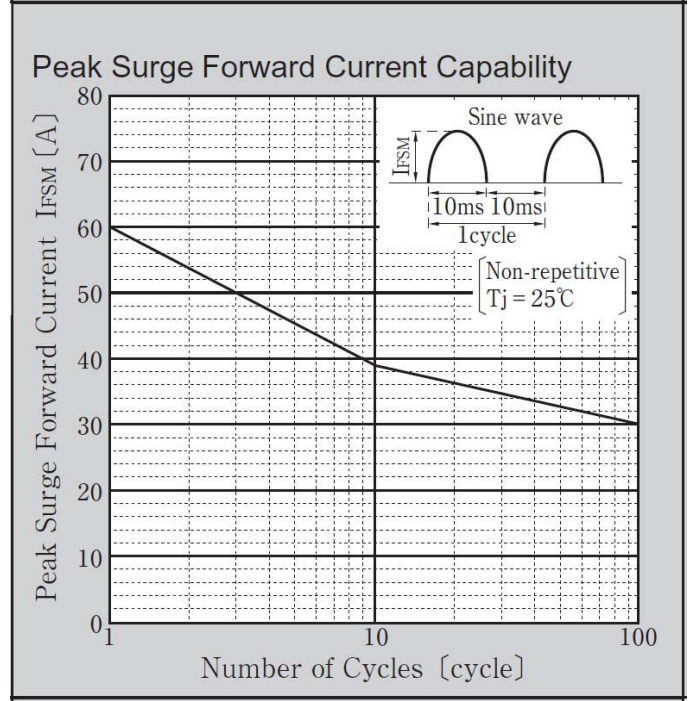
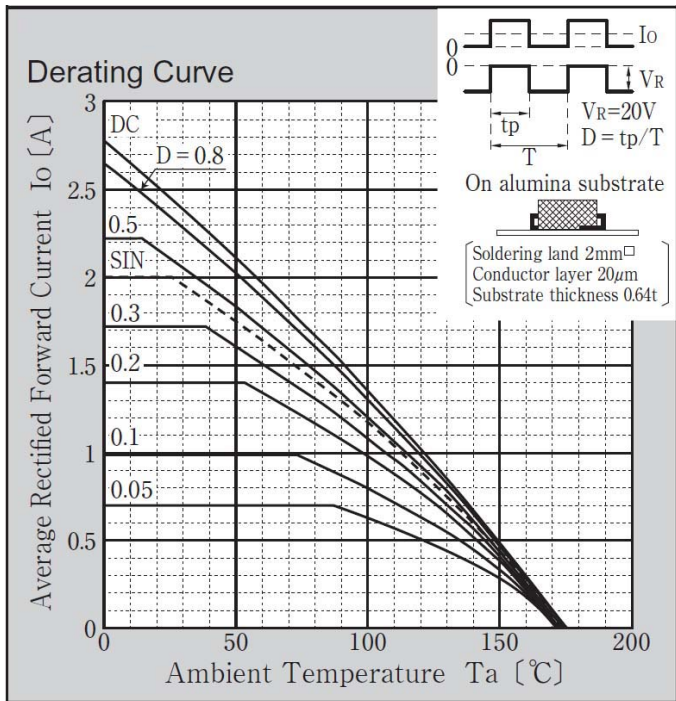
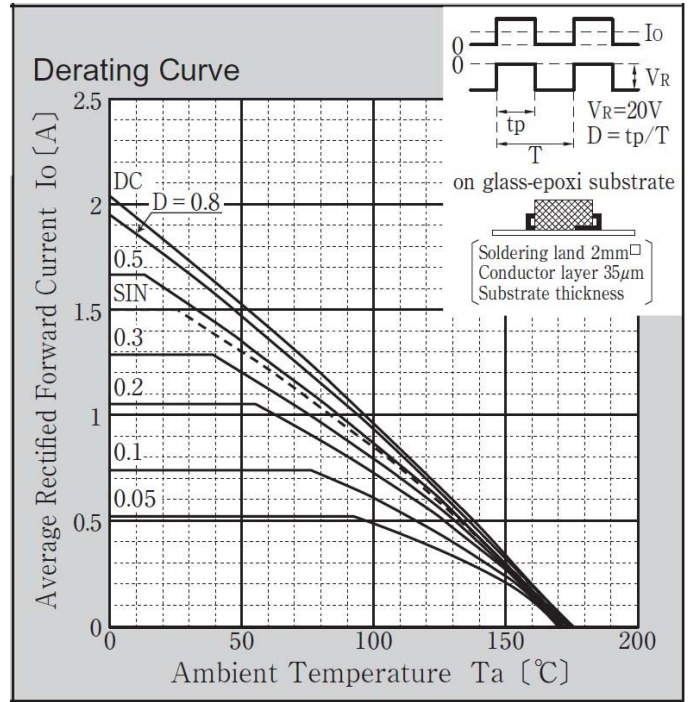
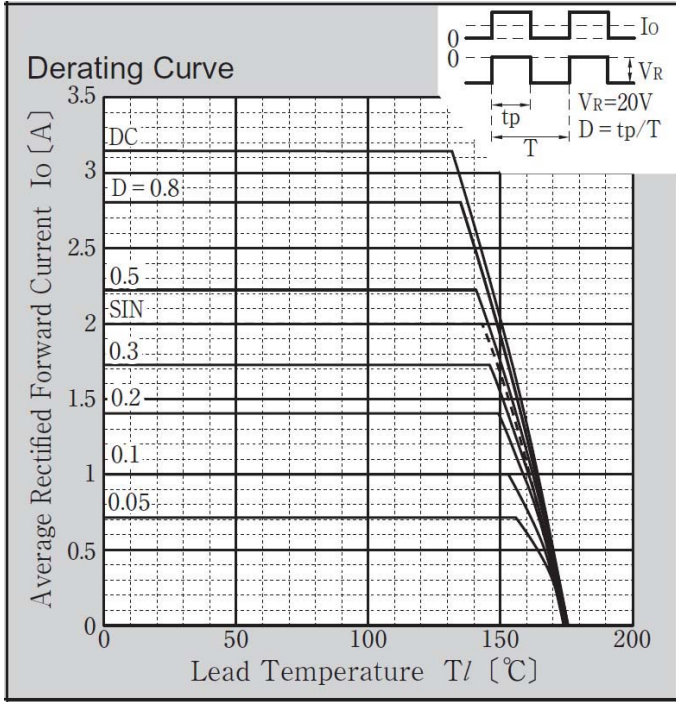


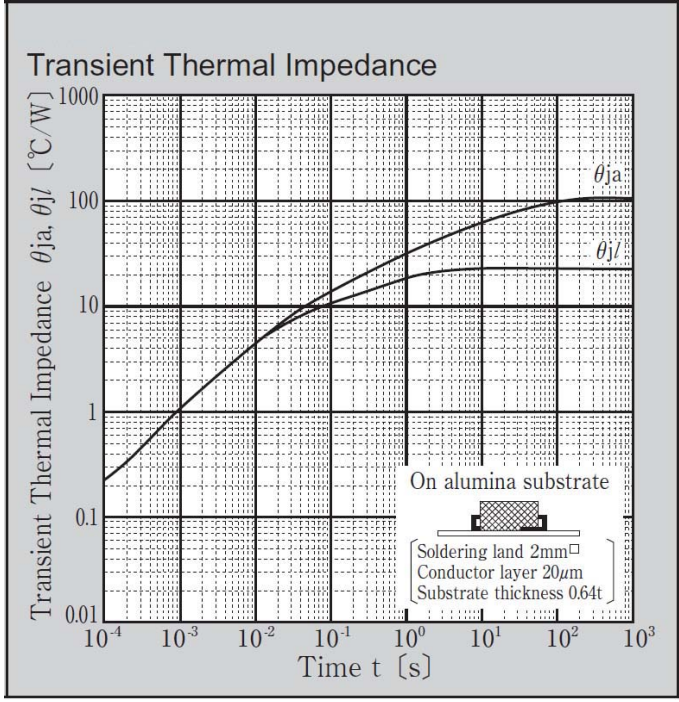
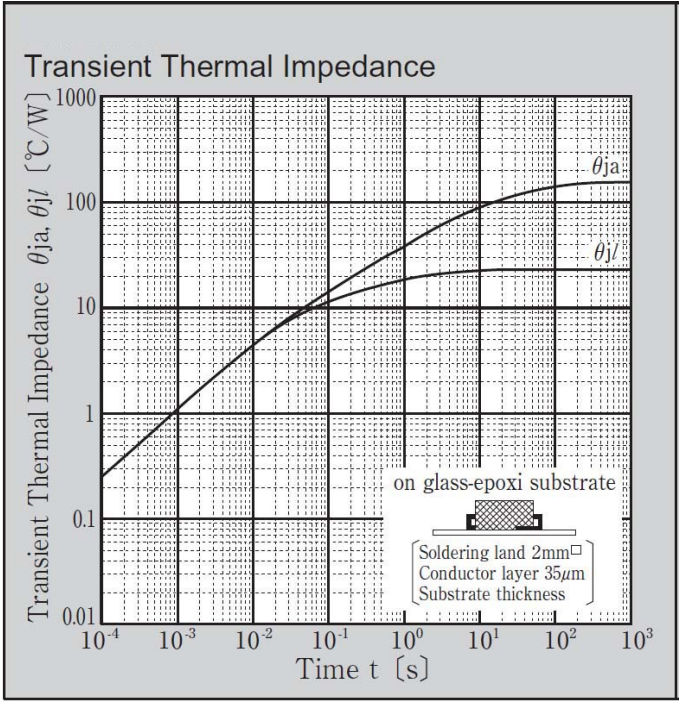
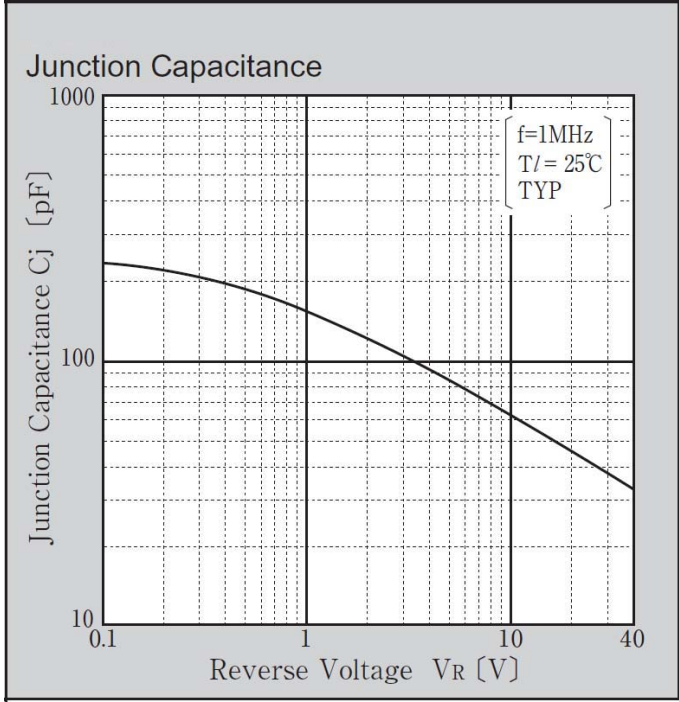
Forward Power Dissipation



Reverse Power Dissipation

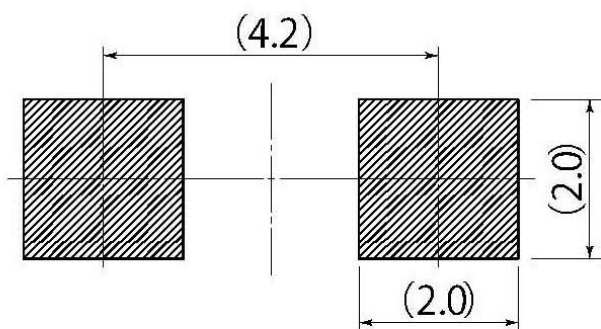
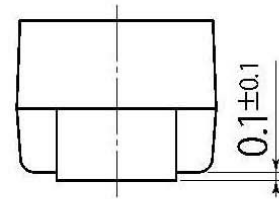
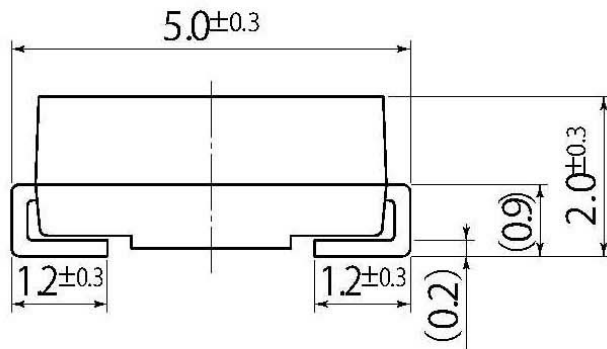
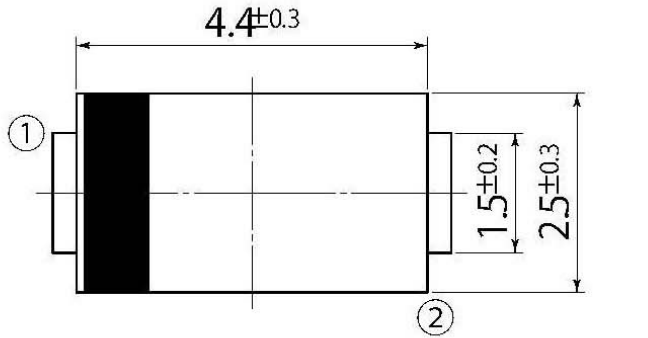






B3

JEDEC Code	DO-214AC
JEITA Code	-
House Name	1F, CF



Referential Soldering Pad

• Optimize soldering pad to the board design and soldering condition.